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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	I²C, IrDA, LINbus, PMP, SPI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	81
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 28x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx450f256lt-120-pt

PIC32MX330/350/370/430/450/470

TABLE 5: PIN NAMES FOR 100-PIN DEVICES

100-PIN TQFP (TOP VIEW)^(1,2)

**PIC32MX430F064L
PIC32MX450F128L
PIC32MX450F256L
PIC32MX470F512L**

100

1

Pin #	Full Pin Name	Pin #	Full Pin Name
1	RG15	36	VSS
2	VDD	37	VDD
3	AN22/RPE5/PMD5/RE5	38	TCK/CTED2/RA1
4	AN23/PMD6/RE6	39	RPF13/RF13
5	AN27/PMD7/RE7	40	RPF12/RF12
6	RPC1/RC1	41	AN12/PMA11/RB12
7	RPC2/RC2	42	AN13/PMA10/RB13
8	RPC3/RC3	43	AN14/RPB14/CTED5/PMA1/RB14
9	RPC4/CTED7/RC4	44	AN15/RPB15/OCFB/CTED6/PMA0/RB15
10	AN16/C1IND/RPG6/SCK2/PMA5/RG6	45	VSS
11	AN17/C1INC/RPG7/PMA4/RG7	46	VDD
12	AN18/C2IND/RPG8/PMA3/RG8	47	RPD14/RD14
13	MCLR	48	RPD15/RD15
14	AN19/C2INC/RPG9/PMA2/RG9	49	RPF4/PMA9/RF4
15	Vss	50	RPF5/PMA8/RF5
16	VDD	51	USBID/RF3
17	TMS/CTED1/RA0	52	RPF2/RF2
18	RPE8/RE8	53	RPF8/RF8
19	RPE9/RE9	54	VBUS
20	AN5/C1INA/RPB5/VBUSON/RB5	55	VUSB3V3
21	AN4/C1INB/RB4	56	D-
22	PGED3/AN3/C2INA/RPB3/RB3	57	D+
23	PGEC3/AN2/C2INB/RPB2/CTED13/RB2	58	SCL2/RA2
24	PGEC1/AN1/RPB1/CTED12/RB1	59	SDA2/RA3
25	PGED1/AN0/RPB0/RB0	60	TDI/CTED9/RA4
26	PGEC2/AN6/RPB6/RB6	61	TDO/RA5
27	PGED2/AN7/RPB7/CTED3/RB7	62	VDD
28	VREF-/CVREF-/PMA7/RA9	63	OSC1/CLKI/RC12
29	VREF+/CVREF+/PMA6/RA10	64	OSC2/CLKO/RC15
30	AVDD	65	VSS
31	AVss	66	SCL1/RPA14/RA14
32	AN8/RPB8/CTED10/RB8	67	SDA1/RPA15/RA15
33	AN9/RPB9/CTED4/RB9	68	RPD8/RTCC/RD8
34	CVREFOUT/AN10/RPB10/CTED11/PMA13/RB10	69	RPD9/RD9
35	AN11/PMA12/RB11	70	RPD10/SCK1/PMCS2/RD10

- Note**
- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 12.3 “Peripheral Pin Select”** for restrictions.
 - 2: Every I/O port pin (RBx-RGx) can be used as a change notification pin (CNBx-CNGx). See **Section 12.0 “I/O Ports”** for more information.

Referenced Sources

This device data sheet is based on the following individual sections of the “*PIC32 Family Reference Manual*”. These documents should be considered as the general reference for the operation of a particular module or device feature.

Note: To access the following documents, refer to the *Documentation > Reference Manuals* section of the Microchip PIC32 website: <http://www.microchip.com/pic32>.

- **Section 1. “Introduction”** (DS60001127)
- **Section 2. “CPU”** (DS60001113)
- **Section 3. “Memory Organization”** (DS60001115)
- **Section 4. “Prefetch Cache”** (DS60001119)
- **Section 5. “Flash Program Memory”** (DS60001121)
- **Section 6. “Oscillator Configuration”** (DS60001112)
- **Section 7. “Resets”** (DS60001118)
- **Section 8. “Interrupt Controller”** (DS60001108)
- **Section 9. “Watchdog Timer and Power-up Timer”** (DS60001114)
- **Section 10. “Power-Saving Features”** (DS60001130)
- **Section 12. “I/O Ports”** (DS60001120)
- **Section 13. “Parallel Master Port (PMP)”** (DS60001128)
- **Section 14. “Timers”** (DS60001105)
- **Section 15. “Input Capture”** (DS60001122)
- **Section 16. “Output Compare”** (DS60001111)
- **Section 17. “10-bit Analog-to-Digital Converter (ADC)”** (DS60001104)
- **Section 19. “Comparator”** (DS60001110)
- **Section 20. “Comparator Voltage Reference (CVREF)”** (DS60001109)
- **Section 21. “Universal Asynchronous Receiver Transmitter (UART)”** (DS60001107)
- **Section 23. “Serial Peripheral Interface (SPI)”** (DS60001106)
- **Section 24. “Inter-Integrated Circuit (I²C)”** (DS60001116)
- **Section 27. “USB On-The-Go (OTG)”** (DS60001126)
- **Section 29. “Real-Time Clock and Calendar (RTCC)”** (DS60001125)
- **Section 31. “Direct Memory Access (DMA) Controller”** (DS60001117)
- **Section 32. “Configuration”** (DS60001124)
- **Section 33. “Programming and Diagnostics”** (DS60001129)
- **Section 37. “Charge Time Measurement Unit (CTMU)”** (DS60001167)

PIC32MX330/350/370/430/450/470

REGISTER 9-2: CHEACC: CACHE ACCESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	CHEWEN	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	—	CHEIDX<3:0>			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31 **CHEWEN:** Cache Access Enable bits for registers CHETAG, CHEMSK, CHEW0, CHEW1, CHEW2, and CHEW3
1 = The cache line selected by CHEIDX<3:0> is writeable
0 = The cache line selected by CHEIDX<3:0> is not writeable

bit 30-4 **Unimplemented:** Write '0'; ignore read

bit 3-0 **CHEIDX<3:0>:** Cache Line Index bits

The value selects the cache line for reading or writing.

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NOTES:

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REGISTER 11-12: U1ADDR: USB ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	LSPDEN	DEVADDR<6:0>						

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7 **LSPDEN:** Low Speed Enable Indicator bit

1 = Next token command to be executed at Low Speed
0 = Next token command to be executed at Full Speed

bit 6-0 **DEVADDR<6:0>:** 7-bit USB Device Address bits

REGISTER 11-13: U1FRML: USB FRAME NUMBER LOW REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	FRML<7:0>							

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7-0 **FRML<7:0>:** The 11-bit Frame Number Lower bits

The register bits are updated with the current frame number whenever a SOF TOKEN is received.

TABLE 12-11: PORTF REGISTER MAP FOR PIC32MX330F064L, PIC32MX350F128L, PIC32MX350F256L, AND PIC32MX370F512L DEVICES ONLY

Virtual Address (BF88_#)	Register Name	Bit Range	Bits																All Registers
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
6510	TRISF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	TRISF13	TRISF12	—	—	—	TRISF8	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	TRISF0	xxxxx
6520	PORTF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	RF13	RF12	—	—	—	RF8	RF7	RF6	RF5	RF4	RF3	RF2	RF1	RF0	xxxxx
6530	LATF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	LATF13	LATF12	—	—	—	LATF8	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	LATF0	xxxxx
6540	ODCF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	—	—	ODCF13	ODCF12	—	—	—	ODCF8	ODCF7	ODCF6	ODCF5	ODCF4	ODCF3	ODCF2	ODCF1	ODCF0	xxxxx
6550	CNPUF	31:16	—	—	—	—	—	—	—	CNPUF8	CNPUF7	CNPUF6	CNPUF5	CNPUF4	CNPDF3	CNPUF2	CNPUF1	CNPUF0	xxxxx
		15:0	—	—	CNPUF13	CNPUF12	—	—	—	—	—	—	—	—	—	—	—	0000	
6560	CNPDF	31:16	—	—	—	—	—	—	—	CNPDF8	CNPDF7	CNPDF6	CNPDF5	CNPDF4	CNPDF3	CNPDF2	CNPDF1	CNPDF0	xxxxx
		15:0	—	—	CNPDF13	CNPDF12	—	—	—	—	—	—	—	—	—	—	—	0000	
6570	CNCONF	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000	
		15:0	ON	—	SIDL	—	—	—	—	—	—	—	—	—	—	—	—	0000	
6580	CNENF	31:16	—	—	—	—	—	—	—	CNIEF8	CNIEF7	—	CNIEF5	CNIEF4	CNIEF3	CNIEF2	CNIEF1	CNIEF0	xxxxx
		15:0	—	—	CNIEF13	CNIEF12	—	—	—	—	—	—	—	—	—	—	—	0000	
6590	CNSTATF	31:16	—	—	—	—	—	—	—	CNSTATF8	CNSTATF7	—	CNSTATF5	CNSTATF4	CNSTATF3	CNSTATF2	CNSTATF1	CNSTATF0	xxxxx
		15:0	—	—	CNSTATF13	CNSTATF12	—	—	—	—	—	—	—	—	—	—	—	0000	

Legend: x = Unknown value on Reset; — = Unimplemented, read as '0'; Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.2 “CLR, SET, and INV Registers”** for more information.

16.0 INPUT CAPTURE

Note: This data sheet summarizes the features of the PIC32MX330/350/370/430/450/470 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 15. “Input Capture”** (DS60001122), which is available from the *Documentation > Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The Input Capture module is useful in applications requiring frequency (period) and pulse measurement.

The Input Capture module captures the 16-bit or 32-bit value of the selected Time Base registers when an event occurs at the ICx pin. The following events cause capture events:

- Simple capture event modes:
 - Capture timer value on every falling edge of input at ICx pin
 - Capture timer value on every rising edge of input at ICx pin
 - Capture timer value on every edge (rising and falling)
 - Capture timer value on every edge (rising and falling), specified edge first.

- Prescaler capture event modes:

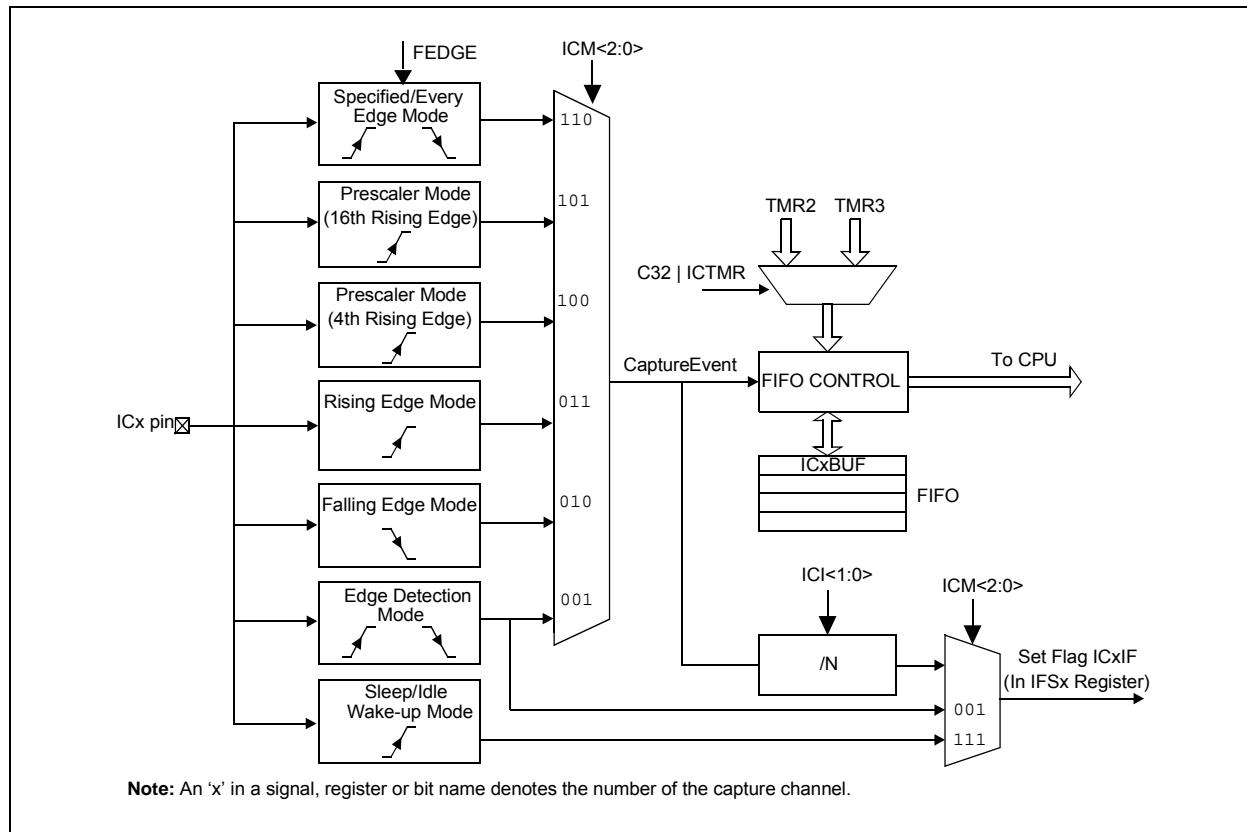
- Capture timer value on every 4th rising edge of input at ICx pin
- Capture timer value on every 16th rising edge of input at ICx pin

Each input capture channel can select between one of two 16-bit timers (Timer2 or Timer3) for the time base, or two 16-bit timers (Timer2 and Timer3) together to form a 32-bit timer. The selected timer can use either an internal or external clock.

Other operational features include:

- Device wake-up from capture pin during CPU Sleep and Idle modes
- Interrupt on input capture event
- 4-word FIFO buffer for capture values
Interrupt optionally generated after 1, 2, 3, or 4 buffer locations are filled
- Input capture can also be used to provide additional sources of external interrupts

FIGURE 16-1: INPUT CAPTURE BLOCK DIAGRAM



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REGISTER 16-1: IC_xCON: INPUT CAPTURE ‘x’ CONTROL REGISTER (CONTINUED)

- bit 2-0 **ICM<2:0>**: Input Capture Mode Select bits
- 111 = Interrupt-Only mode (only supported while in Sleep mode or Idle mode)
 - 110 = Simple Capture Event mode – every edge, specified edge first and every edge thereafter
 - 101 = Prescaled Capture Event mode – every sixteenth rising edge
 - 100 = Prescaled Capture Event mode – every fourth rising edge
 - 011 = Simple Capture Event mode – every rising edge
 - 010 = Simple Capture Event mode – every falling edge
 - 001 = Edge Detect mode – every edge (rising and falling)
 - 000 = Input Capture module is disabled

Note 1: When using 1:1 PBCLK divisor, the user software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

18.0 SERIAL PERIPHERAL INTERFACE (SPI)

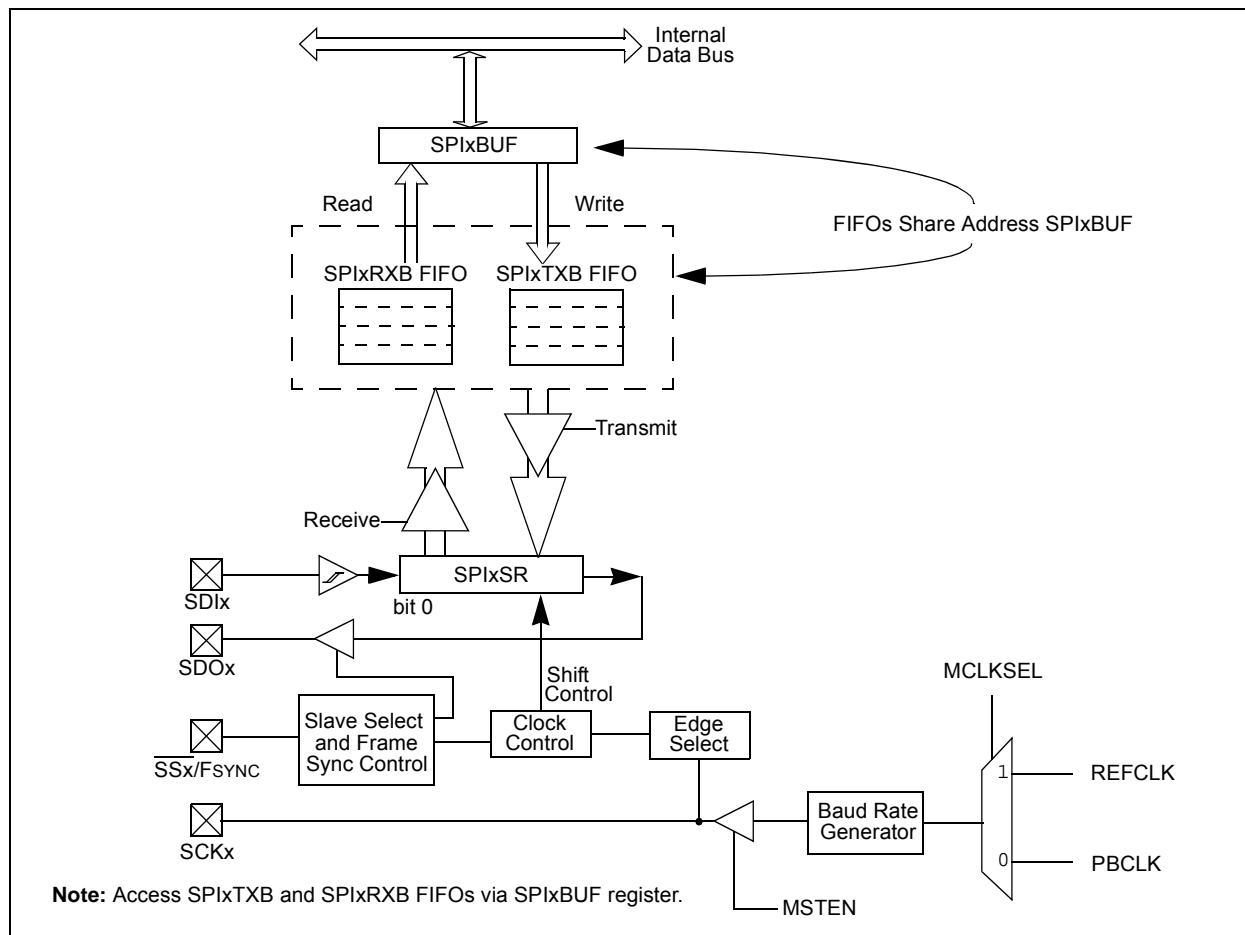
Note: This data sheet summarizes the features of the PIC32MX330/350/370/430/450/470 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 23. "Serial Peripheral Interface (SPI)"** (DS60001106), which is available from the *Documentation > Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

The SPI module is a synchronous serial interface that is useful for communicating with external peripherals and other microcontroller devices. These peripheral devices may be Serial EEPROMs, Shift registers, display drivers, Analog-to-Digital Converters (ADC), etc. The PIC32 SPI module is compatible with Motorola® SPI and SIOP interfaces.

Some of the key features of the SPI module are:

- Master and Slave modes support
- Four different clock formats
- Enhanced Framed SPI protocol support
- User-configurable 8-bit, 16-bit and 32-bit data width
- Separate SPI FIFO buffers for receive and transmit
 - FIFO buffers act as 4/8/16-level deep FIFOs based on 32/16/8-bit data width
- Programmable interrupt event on every 8-bit, 16-bit and 32-bit data transfer
- Operation during CPU Sleep and Idle mode
- Audio Codec Support:
 - I²S protocol
 - Left-justified
 - Right-justified
 - PCM

FIGURE 18-1: SPI MODULE BLOCK DIAGRAM



20.1 Control Registers

TABLE 20-1: UART1 THROUGH UART5 REGISTER MAP

Virtual Address (BF80_#)	Register Name	Bit Range	Bits																All Resets	
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0		
6000	U1MODE ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>	STSEL	0000			
6010	U1STA ⁽¹⁾	31:16	—	—	—	—	—	—	ADM_EN	ADDR<7:0>										0000
		15:0	UTXISEL<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	FFFF			
6020	U1TXREG	31:16	—	—	—	—	—	—	—	Transmit Register										0000
		15:0	—	—	—	—	—	—	TX8	Receive Register										0000
6030	U1RXREG	31:16	—	—	—	—	—	—	—	RX8										0000
		15:0	—	—	—	—	—	—	—	Baud Rate Generator Prescaler										0000
6040	U1BRG ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	All Resets																0000	
6200	U2MODE ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>	STSEL	0000			
6210	U2STA ⁽¹⁾	31:16	—	—	—	—	—	—	ADM_EN	ADDR<7:0>										0000
		15:0	UTXISEL<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	FFFF			
6220	U2TXREG	31:16	—	—	—	—	—	—	—	Transmit Register										0000
		15:0	—	—	—	—	—	—	TX8	Receive Register										0000
6230	U2RXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	—	—	—	—	—	—	RX8	Baud Rate Generator Prescaler										0000
6240	U2BRG ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	All Resets																0000	
6400	U3MODE ⁽¹⁾	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>	STSEL	0000			
6410	U3STA ⁽¹⁾	31:16	—	—	—	—	—	—	ADM_EN	ADDR<7:0>										0000
		15:0	UTXISEL<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	FFFF			
6420	U3TXREG	31:16	—	—	—	—	—	—	—	Transmit Register										0000
		15:0	—	—	—	—	—	—	TX8	Receive Register										0000
6430	U3RXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000		
		15:0	—	—	—	—	—	—	RX8	Baud Rate Generator Prescaler										0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.2 “CLR, SET, and INV Registers”** for more information.

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REGISTER 22-2: RTCALRM: RTC ALARM CONTROL REGISTER (CONTINUED)

bit 7-0 **ARPT<7:0>**: Alarm Repeat Counter Value bits⁽³⁾

11111111 = Alarm will trigger 256 times

.

.

00000000 = Alarm will trigger one time

The counter decrements on any alarm event. The counter only rolls over from 0x00 to 0xFF if CHIME = 1.

Note 1: Hardware clears the ALRMEN bit anytime the alarm event occurs, when ARPT<7:0> = 00 and CHIME = 0.

2: This field should not be written when the RTCC ON bit = '1' (RTCCON<15>) and ALRMSYNC = 1.

3: This assumes a CPU read will execute in less than 32 PBCLKs.

Note: This register is reset only on a Power-on Reset (POR).

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REGISTER 22-4: RTCDATE: RTC DATE VALUE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	YEAR10<3:0>							
23:16	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	MONTH10<3:0>							
15:8	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
	DAY10<3:0>							
7:0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x
	—	—	—	—	WDAY01<3:0>			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 31-28 **YEAR10<3:0>**: Binary-Coded Decimal Value of Years bits, 10s place digits

bit 27-24 **YEAR01<3:0>**: Binary-Coded Decimal Value of Years bits, 1s place digit

bit 23-20 **MONTH10<3:0>**: Binary-Coded Decimal Value of Months bits, 10s place digits; contains a value of 0 or 1

bit 19-16 **MONTH01<3:0>**: Binary-Coded Decimal Value of Months bits, 1s place digit; contains a value from 0 to 9

bit 15-12 **DAY10<3:0>**: Binary-Coded Decimal Value of Days bits, 10s place digits; contains a value from 0 to 3

bit 11-8 **DAY01<3:0>**: Binary-Coded Decimal Value of Days bits, 1s place digit; contains a value from 0 to 9

bit 7-4 **Unimplemented**: Read as '0'

bit 3-0 **WDAY01<3:0>**: Binary-Coded Decimal Value of Weekdays bits, 1s place digit; contains a value from 0 to 6

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

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TABLE 31-8: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symb.	Characteristics	Min.	Typ. ⁽¹⁾	Max.	Units	Conditions
DI60b	I _I CH	Input High Injection Current	0	—	+5 ^(8,9,10)	mA	Pins with Analog functions. Exceptions: [SOSCI, SOSCO, OSC1, D+, D-] = 0 mA max.
							Digital 5V tolerant designated pins ($V_{IH} < 5.5V$) ⁽⁹⁾ . Exceptions: [All] = 0 mA max.
							Digital non-5V tolerant designated pins. Exceptions: [N/A] = 0 mA max.
DI60c	Σ I _{ICT}	Total Input Injection Current (sum of all I/O and control pins)	-20 ⁽¹¹⁾	—	+20 ⁽¹¹⁾	mA	Absolute instantaneous sum of all \pm input injection currents from all I/O pins ($ I_{ICL} + I_{IHC} \leq \Sigma I_{ICT}$)

- Note 1:** Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 2:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as current sourced by the pin.
- 4:** This parameter is characterized, but not tested in manufacturing.
- 5:** See the “Device Pin Tables” section for the 5V tolerant pins.
- 6:** The V_{IH} specifications are only in relation to externally applied inputs, and not with respect to the user-selectable internal pull-ups. External open drain input signals utilizing the internal pull-ups of the PIC32 device are guaranteed to be recognized only as a logic “high” internally to the PIC32 device, provided that the external load does not exceed the minimum value of I_{CNP}. For External “input” logic inputs that require a pull-up source, to guarantee the minimum V_{IH} of those components, it is recommended to use an external pull-up resistor rather than the internal pull-ups of the PIC32 device.
- 7:** V_{IL} source < (V_{SS} - 0.3). Characterized but not tested.
- 8:** V_{IH} source > (V_{DD} + 0.3) for non-5V tolerant pins only.
- 9:** Digital 5V tolerant pins do not have an internal high side diode to V_{DD}, and therefore, cannot tolerate any “positive” input injection current.
- 10:** Injection currents $> |0|$ can affect the ADC results by approximately 4 to 6 counts (i.e., V_{IH} Source > (V_{DD} + 0.3) or V_{IL} source < (V_{SS} - 0.3)).
- 11:** Any number and/or combination of I/O pins not excluded under I_{ICL} or I_{IHC} conditions are permitted provided the “absolute instantaneous” sum of the input injection currents from all pins do not exceed the specified limit. If **Note 7**, I_{ICL} = (((V_{SS} - 0.3) - V_{IL} source) / R_S). If **Note 8**, I_{IHC} = ((I_{IHC} source - (V_{DD} + 0.3)) / R_S). R_S = Resistance between input source voltage and device pin. If (V_{SS} - 0.3) \leq V_{SOURCE} \leq (V_{DD} + 0.3), injection current = 0.

31.2 AC Characteristics and Timing Parameters

The information contained in this section defines PIC32MX330/350/370/430/450/470 AC characteristics and timing parameters.

FIGURE 31-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

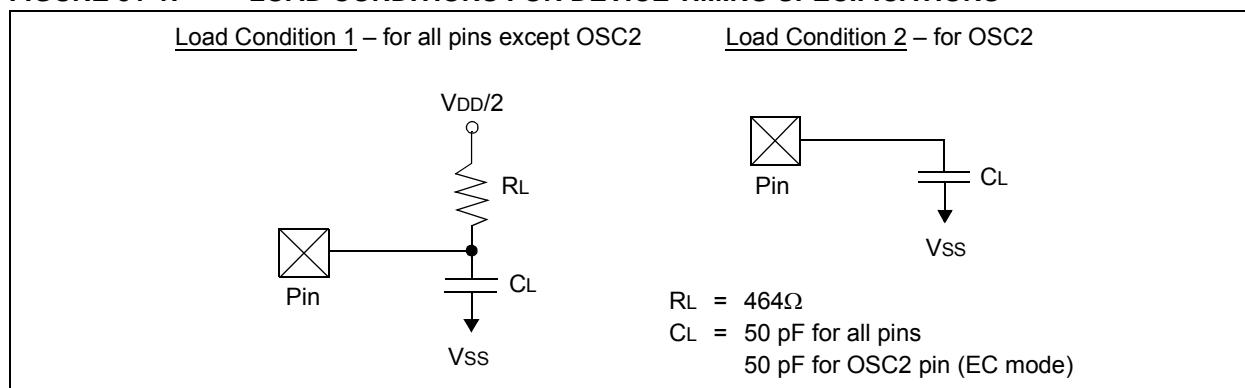
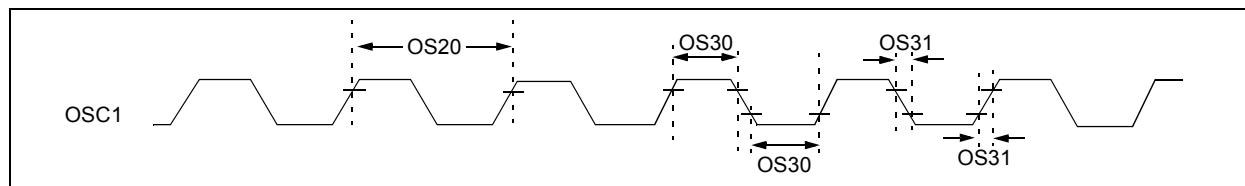


TABLE 31-17: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics	Min.	Typical ⁽¹⁾	Max.	Units	Conditions
DO50	Cosco	OSC2 pin	—	—	15	pF	In XT and HS modes when an external crystal is used to drive OSC1
DO56	Cio	All I/O pins and OSC2	—	—	50	pF	EC mode
DO58	CB	SCLx, SDAx	—	—	400	pF	In I ² C mode

Note 1: Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 31-2: EXTERNAL CLOCK TIMING



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FIGURE 31-8: OUTPUT COMPARE MODULE (OCx) TIMING CHARACTERISTICS

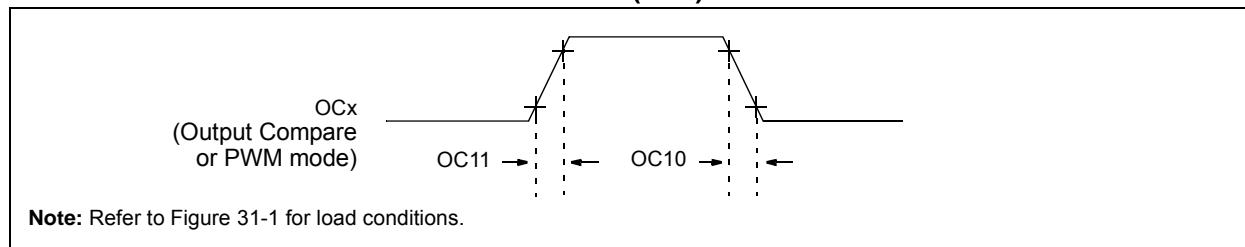


TABLE 31-27: OUTPUT COMPARE MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typical ⁽²⁾	Max.	Units	Conditions
OC10	TccF	OCx Output Fall Time	—	—	—	ns	See parameter DO32
OC11	TccR	OCx Output Rise Time	—	—	—	ns	See parameter DO31

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 31-9: OCx/PWM MODULE TIMING CHARACTERISTICS

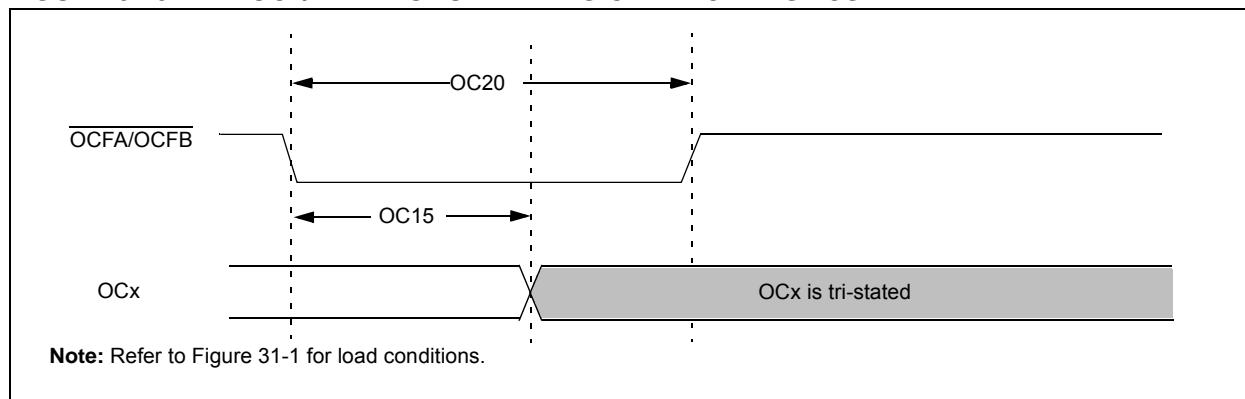


TABLE 31-28: SIMPLE OCx/PWM MODE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min	Typical ⁽²⁾	Max	Units	Conditions
OC15	TFD	Fault Input to PWM I/O Change	—	—	50	ns	—
OC20	TFLT	Fault Input Pulse Width	50	—	—	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

FIGURE 31-11: SPI_x MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS

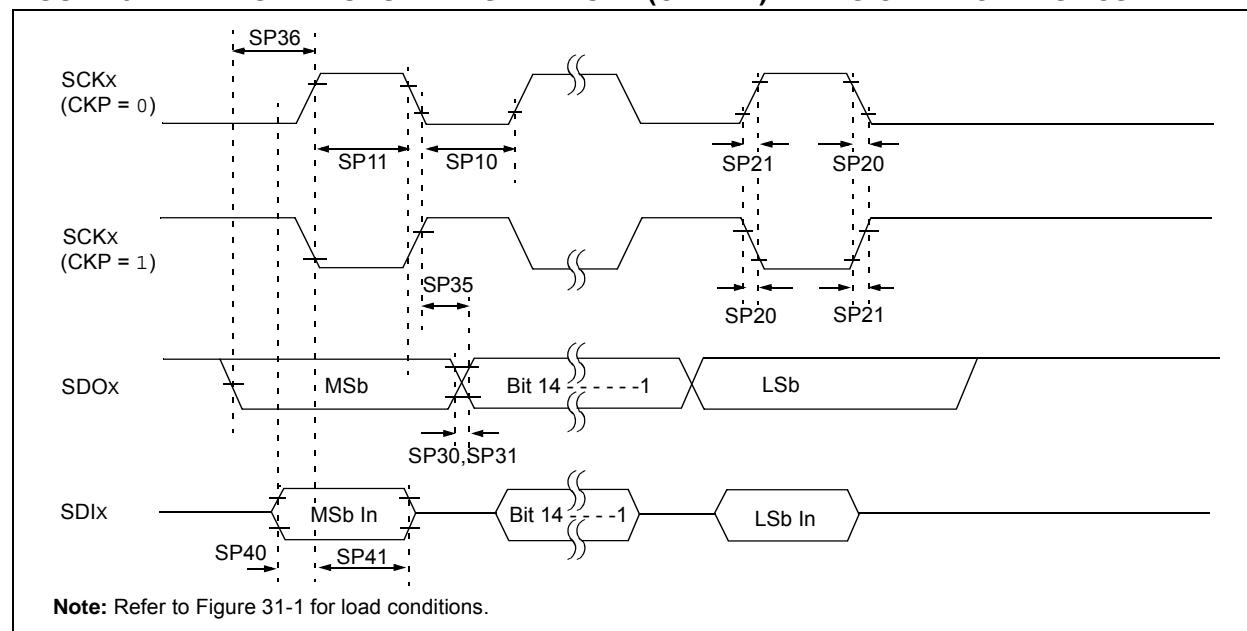


TABLE 31-30: SPI_x MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units	Conditions
SP10	TsCL	SCK _x Output Low Time (Note 3)	TsCK/2	—	—	ns	—
SP11	TsCH	SCK _x Output High Time (Note 3)	TsCK/2	—	—	ns	—
SP20	TsCF	SCK _x Output Fall Time (Note 4)	—	—	—	ns	See parameter DO32
SP21	TsCR	SCK _x Output Rise Time (Note 4)	—	—	—	ns	See parameter DO32
SP30	TDOF	SDO _x Data Output Fall Time (Note 4)	—	—	—	ns	See parameter DO32
SP31	TDOF	SDO _x Data Output Rise Time (Note 4)	—	—	—	ns	See parameter DO31
SP35	TsCH2DOV, TsCL2DOV	SDO _x Data Output Valid after SCK _x Edge	—	—	15	ns	VDD > 2.7V
			—	—	20	ns	VDD < 2.7V
SP36	TDOV2sc, TDOV2scl	SDO _x Data Output Setup to First SCK _x Edge	15	—	—	ns	—
SP40	TDIV2scl, TDIV2scl	Setup Time of SDIx Data Input to SCK _x Edge	15	—	—	ns	VDD > 2.7V
			20	—	—	ns	VDD < 2.7V
SP41	TsCH2DIL, TsCL2DIL	Hold Time of SDIx Data Input to SCK _x Edge	15	—	—	ns	VDD > 2.7V
			20	—	—	ns	VDD < 2.7V

Note 1: These parameters are characterized, but not tested in manufacturing.

- 2:** Data in “Typical” column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3:** The minimum clock period for SCK_x is 40 ns. Therefore, the clock generated in Master mode must not violate this specification.
- 4:** Assumes 50 pF load on all SPI_x pins.

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TABLE 31-33: I²C BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)			
Param. No.	Symbol	Characteristics	Min. ⁽¹⁾	Max.	Units	Conditions
IM10	TLO:SCL	Clock Low Time	100 kHz mode	TPB * (BRG + 2)	—	μs
			400 kHz mode	TPB * (BRG + 2)	—	μs
			1 MHz mode (Note 2)	TPB * (BRG + 2)	—	μs
IM11	THI:SCL	Clock High Time	100 kHz mode	TPB * (BRG + 2)	—	μs
			400 kHz mode	TPB * (BRG + 2)	—	μs
			1 MHz mode (Note 2)	TPB * (BRG + 2)	—	μs
IM20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns
			400 kHz mode	20 + 0.1 CB	300	ns
			1 MHz mode (Note 2)	—	100	ns
IM21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns
			400 kHz mode	20 + 0.1 CB	300	ns
			1 MHz mode (Note 2)	—	300	ns
IM25	Tsu:DAT	Data Input Setup Time	100 kHz mode	250	—	ns
			400 kHz mode	100	—	ns
			1 MHz mode (Note 2)	—	100	ns
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	μs
			400 kHz mode	0	0.9	μs
			1 MHz mode (Note 2)	0	0.3	μs
IM30	Tsu:STA	Start Condition Setup Time	100 kHz mode	TPB * (BRG + 2)	—	μs
			400 kHz mode	TPB * (BRG + 2)	—	μs
			1 MHz mode (Note 2)	TPB * (BRG + 2)	—	μs
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	TPB * (BRG + 2)	—	μs
			400 kHz mode	TPB * (BRG + 2)	—	μs
			1 MHz mode (Note 2)	TPB * (BRG + 2)	—	μs
IM33	Tsu:STO	Stop Condition Setup Time	100 kHz mode	TPB * (BRG + 2)	—	μs
			400 kHz mode	TPB * (BRG + 2)	—	μs
			1 MHz mode (Note 2)	TPB * (BRG + 2)	—	μs

Note 1: BRG is the value of the I²C Baud Rate Generator.

2: Maximum pin capacitance = 10 pF for all I²Cx pins (for 1 MHz mode only).

3: The typical value for this parameter is 104 ns.

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TABLE 31-41: OTG ELECTRICAL SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)				
Param. No.	Symbol	Characteristics ⁽¹⁾	Min.	Typ.	Max.	Units	Conditions
USB313	VUSB3V3	USB Voltage	3.0	—	3.6	V	Voltage on VUSB3V3 must be in this range for proper USB operation
USB315	VILUSB	Input Low Voltage for USB Buffer	—	—	0.8	V	—
USB316	VIHUSB	Input High Voltage for USB Buffer	2.0	—	—	V	—
USB318	VDIFS	Differential Input Sensitivity	—	—	0.2	V	The difference between D+ and D- must exceed this value while VCM is met
USB319	VCM	Differential Common Mode Range	0.8	—	2.5	V	—
USB320	ZOUT	Driver Output Impedance	28.0	—	44.0	Ω	—
USB321	VO _L	Voltage Output Low	0.0	—	0.3	V	1.425 k Ω load connected to VUSB3V3
USB322	VO _H	Voltage Output High	2.8	—	3.6	V	14.25 k Ω load connected to ground

Note 1: These parameters are characterized, but not tested in manufacturing.

FIGURE 32-9: TYPICAL I_{IDLE} CURRENT @ V_{DD} = 3.3V

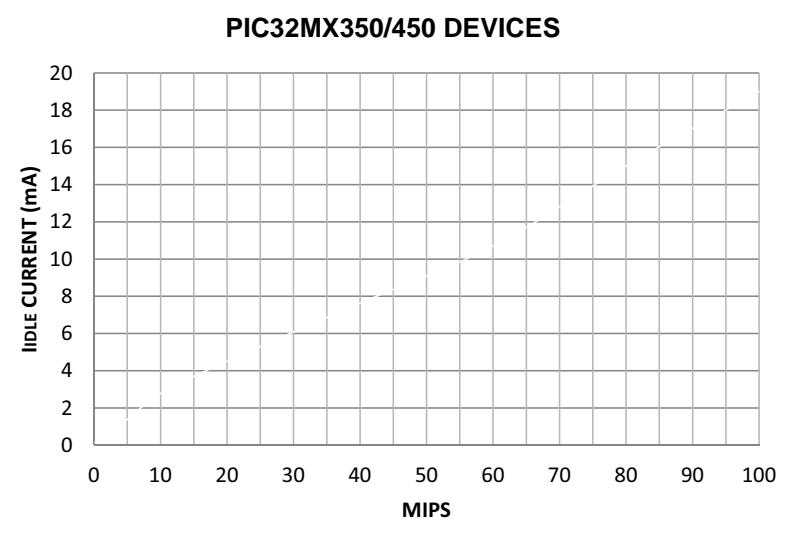


FIGURE 32-10: TYPICAL I_{IDLE} CURRENT @ V_{DD} = 3.3V

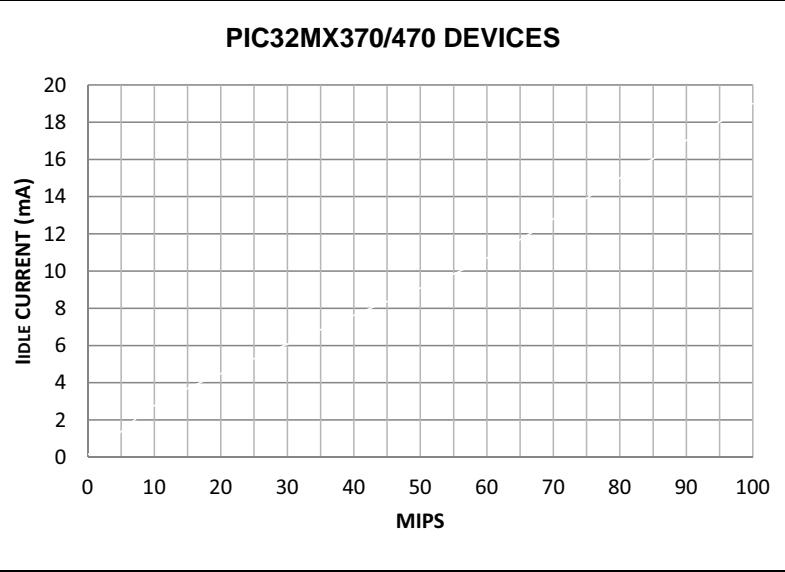


FIGURE 32-11: TYPICAL I_{DD} CURRENT @ V_{DD} = 3.3V

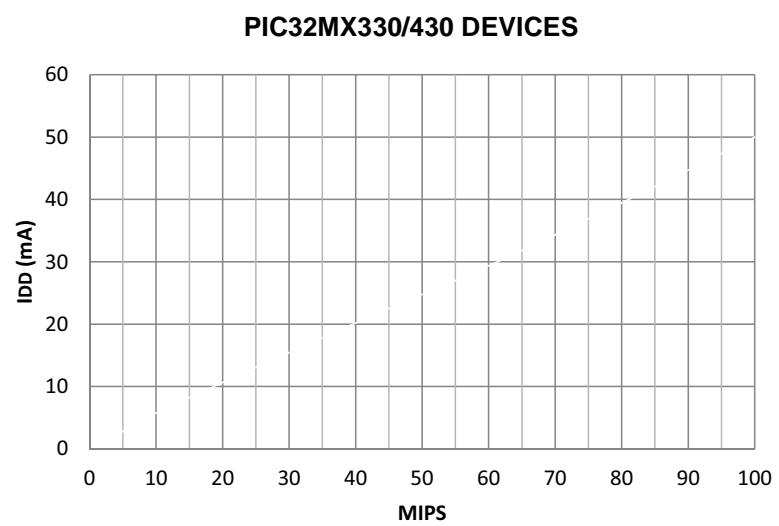
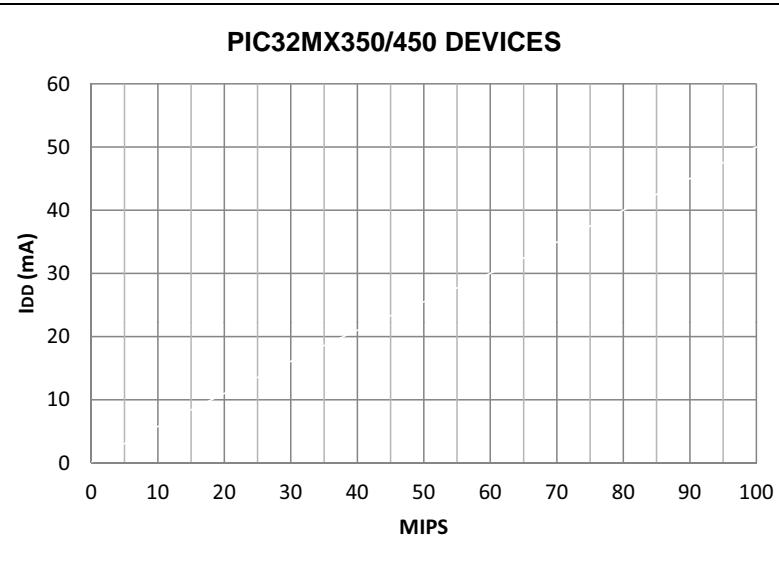


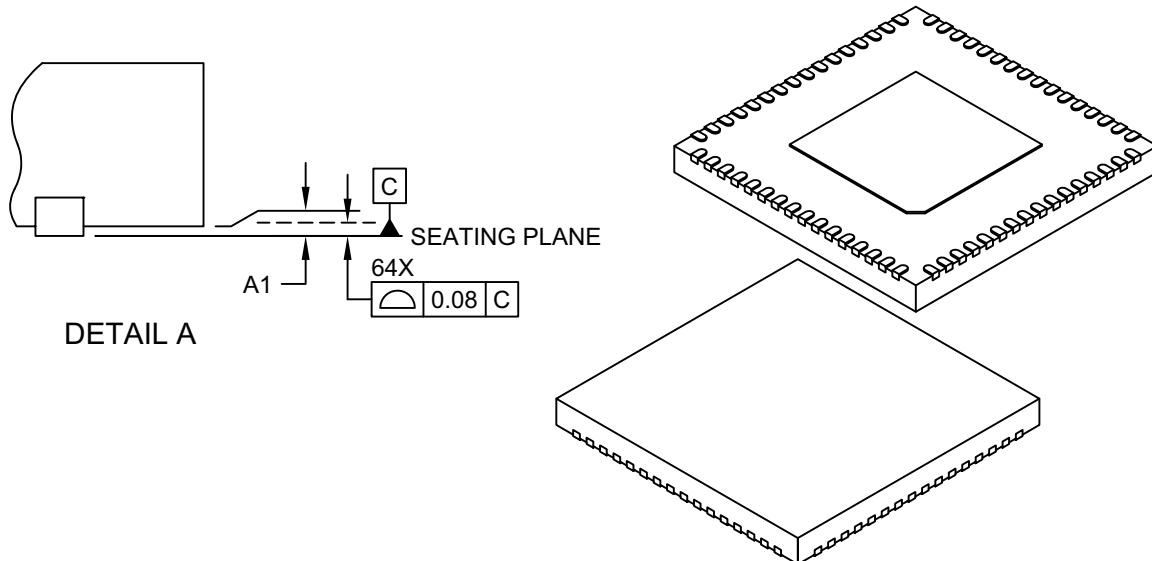
FIGURE 32-12: TYPICAL I_{DD} CURRENT @ V_{DD} = 3.3V



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64-Terminal Plastic Quad Flat Pack, No Lead (RG) 9x9x0.9 mm Body [QFN] Saw Singulated

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
		Dimension Limits	MIN	NOM	MAX
Number of Terminals		N		64	
Pitch		e		0.50 BSC	
Overall Height		A		0.80	0.85
Standoff		A1		0.00	0.02
Standoff		A3		0.20 REF	
Overall Width		E		9.00 BSC	
Exposed Pad Width		E2		4.60	4.70
Overall Length		D		9.00 BSC	
Exposed Pad Length		D2		4.60	4.70
Terminal Width		b		0.15	0.20
Terminal Length		L		0.30	0.40
Terminal-to-Exposed-Pad		K		1.755 REF	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.